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PETITION FOR EXTENSION OF TIME UNDER 37 CFR 1.136(a) Docket Number (Optional)			Docket Number (Optional)
6793	In re Application	of Charles Lev	ı et al.
DEC 1 1 2003 &	. • .	0 DITT OXIDE THIN	iled 1/08/02 FILM FILTER FOR ION MULTIPLEXING PRITCHETT
This is a request under the provisions of 37 CFR 1.136(a) to extend the period for filing a response in the above identified application.			
The requested extension and a (check time period desired):		mall-entity fee are a	s follows \$_110.00
Two months (37 CFR 1.17(a)(2))		\$	
Three months (37 CFR 1.17(a)(3))			\$
Four months (37 CFR 1.17(a)(4))			\$
Five months (37 CFR	1.17 (a)(5))		\$
Applicant is a small entity under 37 CFR 1.9 and 1.27, therefore the fee amount shown above is reduced by one-half, and the resulting fee is: \$			
has already be	een filed in this a		·
A check in the amount of the fee is enclosed.			
The Commissioner has already been authorized to charge fees in this application to a Deposit Account.			
The Commissioner is hereby authorized to charge any fees which may be required, or credit any overpayment, to Deposit Account Number I have enclosed a duplicate copy of this sheet.			
I am the assignee of reco	rd of the entire in	nterest.	ō C
applicant.	•		MAIL ROOM
x attorney or agen	t of record.		2003 IL ROC
attorney or agen	t under 37 CFR		Ĭ /
Date Wei Te Chung			
Typed or printed name			

Burden Hour Statement: This form is estimated to take 0.1 hours to complete. Time wuvery depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.